SCAS541B - OCTOBER 1995 - REVISED JUNE 1996

- 3-State Outputs Drive Bus Lines Directly
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-µm Process
- **Package Options Include Plastic** Small-Outline (DW) Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIP Packages

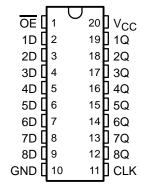
description

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

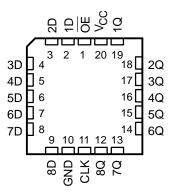
The eight flip-flops of the 'AC574 are D-type edge-triggered flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the highimpedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines in a bus-organized system without need for interface or pullup components.

SN54AC574...J OR W PACKAGE SN74AC574 . . . DB. DW. N. OR PW PACKAGE (TOP VIEW)



SN54AC574...FK PACKAGE (TOP VIEW)



OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AC574 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AC574 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each flip-flop)

	INPUTS		OUTPUT
0E	CLK	D	Q
L	↑	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	X	Χ	Z



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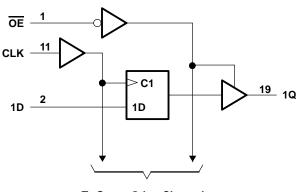
SN54AC574, SN74AC574 OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

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logic symbol†

OE ΕN CLK > C1 2 19 1D 1D 1Q 3 18 2Q 2D 4 17 3D 3Q 5 16 4D 4Q 15 6 5D 5Q 7 14 6D 6Q 8 13 7D **7Q** 9 12 8D 8Q

logic diagram (positive logic)



To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range, V _I (see Note 1)		$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)		$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)		±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)		
Continuous output current, I_O ($V_O = 0$ to V_{CC})		
Continuous current through V _{CC} or GND		
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2)		
, , , , , , , , , , , , , , , , , , , ,	DW package	1.6 W
	N package	1.3 W
	PW package	0.7 W
Storage temperature range, T _{stq}		65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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recommended operating conditions (see Note 3)

			SN54	SN54AC574		AC574	UNIT
			MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage		2	6	2	6	V
		V _{CC} = 3 V	2.1		2.1		
VIH	High-level input voltage	V _{CC} = 4.5 V	3.15		3.15		V
		V _{CC} = 5.5 V	3.85		3.85		
		V _{CC} = 3 V		0.9		0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5V$		1.35		1.35	V
		V _{CC} = 5.5 V		1.65		1.65	
٧ _I	Input voltage		0	Vcc	0	Vcc	V
٧o	Output voltage		0	VCC	0	Vcc	V
		V _{CC} = 3 V		-12		-12	
IOH	High-level output current	$V_{CC} = 4.5 \text{ V}$		-24		-24	mA
		V _{CC} = 5.5 V		-24		-24	
		V _{CC} = 3 V		12		12	
lOL	Low-level output current	V _{CC} = 4.5 V		24		24	mA
		V _{CC} = 5.5 V		24		24	
Δt/Δν	Input transition rise or fall rate		0	8	0	8	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST COMPLIANS	V	1	A = 25°	С	SN54	AC574	SN74/	AC574	UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	וואט ך
		3 V	2.9			2.9		2.9		
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
Va.,		5.5 V	5.4			5.4		5.4		V
VOH	I _{OH} = −12 mA	3 V	2.56			2.4		2.46		V
	loυ - 24 mΔ	4.5 V	3.94			3.7		3.76		
	I _{OH} = -24 mA	5.5 V	4.94			4.7		4.76		
		3 V			0.1		0.1		0.1	
	$I_{OL} = 50 \mu A$	4.5 V			0.1		0.1		0.1	
V		5.5 V			0.1		0.1		0.1	V
V _{OL}	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V
	lo 24 mA	4.5 V			0.36		0.5		0.44	
	$I_{OL} = 24 \text{ mA}$	5.5 V			0.36		0.5		0.44	
IĮ	V _I = V _{CC} or GND	5.5 V			±0.1		±1		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.5		±5		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		80		40	μΑ
Ci	V _I = V _{CC} or GND	5 V		4.5						pF

SN54AC574, SN74AC574 OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

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timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		T _A = 25°C SN54AC5		SN74A	C574	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	ONIT
t _W	Pulse duration, CLK high or low	6		7.5		7		ns
t _{su}	Setup time, data before CLK↑	2.5		6.5		3		ns
th	Hold time, data after CLK↑	1.5		2.5		1.5		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C SN54AC574		SN74AC574		UNIT		
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _W	Pulse duration, CLK high or low	4		5		5		ns
t _{su}	Setup time, data before CLK↑	1.5		3.5		2		ns
th	Hold time, data after CLK↑	1.5		2.5		1.5		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	то	то	T,	_A = 25°C	;	SN54A	C574	SN74A	C574	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
fmax			75	112		55		60		MHz
^t PLH	CLK	Q	3.5	8.5	13.5	1	16.5	3.5	15	20
^t PHL	OLK	y	3.5	7.5	12	1	15	3.5	13.5	ns
^t PZH	<u>OE</u>	Q	2.5	7	11	1	13	2.5	12	ns
t _{PZL}	OE	y	3	6.5	10.5	1	12.5	3	11.5	115
^t PHZ	ŌĒ	Q	3.5	7.5	12	1	14	2.5	13	20
t _{PLZ}	OE	y	2	5.5	9	1	10.5	1.5	10	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

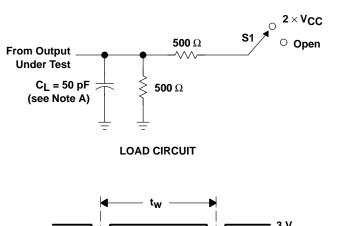
PARAMETER	то	ТО	T,	4 = 25°C	;	SN54A	C574	SN74A	C574	UNIT
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONIT
f _{max}			95	153		85		85		MHz
^t PLH	CLK	Q	2	6	9.5	1.5	11.5	2	11	ns
^t PHL) JEN	y	2	5.5	8.5	1.5	10.5	2	9.5	10
^t PZH	<u>OE</u>	Q	2	5	8.5	1.5	9.5	2	9	ns
t _{PZL}	OE	y	2	5	8	1.5	9.5	1.5	9	110
^t PHZ	ŌĒ	Q	2	6	9.5	1.5	11.5	1.5	10.5	ns
^t PLZ	OE .	Q	1	4.5	7.5	1.5	9	1	8.5	115

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

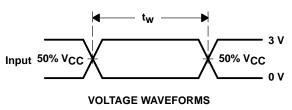
	PARAMETER		TEST CONDITIONS		
C _{pd}	Power dissipation capacitance	C _L = 50 pF,	f = 1 MHz	40	pF

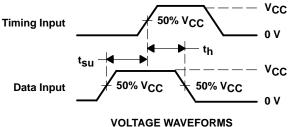


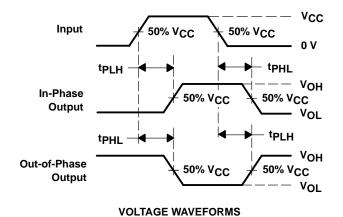
PARAMETER MEASUREMENT INFORMATION

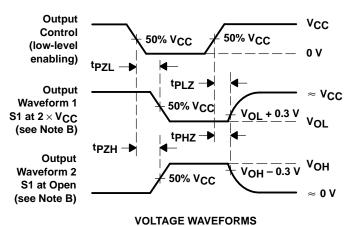


TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	2×V _{CC}
tPHZ/tPZH	Open









NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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